

Feature

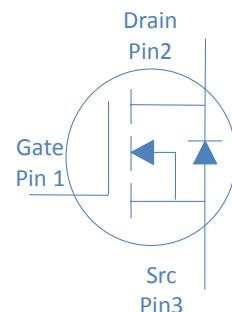
- ◇ High Speed Power Smooth Switching, Logic Level
- ◇ Enhanced Body diode dv/dt capability
- ◇ Enhanced Avalanche Ruggedness
- ◇ 100% UIS Tested, 100% Rg Tested
- ◇ Lead Free

Application

- ◇ Synchronous Rectification in SMPS
- ◇ Hard Switching and High Speed Circuit
- ◇ Power Tools
- ◇ UPS
- ◇ Motor Control

200V N-Ch Power MOSFET

V_{DS}	200	V	
$R_{DS(on),typ}$	$V_{GS}=10V$	95	mΩ
$R_{DS(on),typ}$	$V_{GS}=4.5V$	106	mΩ
I_D	18	A	

TO-220


Part Number	Package	Marking
HGP1K2N20ML	TO-220	GP1K2N20ML

Absolute Maximum Ratings at $T_j=25^\circ C$ (unless otherwise specified)

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current	I_D	$T_C=25^\circ C$	18.2	A
		$T_C=100^\circ C$	12.8	
Drain to Source Voltage	V_{DS}	-	200	V
Gate to Source Voltage	V_{GS}	-	± 20	V
Pulsed Drain Current	I_{DM}	-	25	A
Avalanche Energy, Single Pulse	E_{AS}	$L=0.4mH, T_C=25^\circ C$	5	mJ
Power Dissipation	P_D	$T_C=25^\circ C$	88	W
Operating and Storage Temperature	T_J, T_{stg}	-	-55 to 175	°C

Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Thermal Resistance Junction-Case	R_{eJC}	1.7	°C/W
Thermal Resistance Junction-Ambient	R_{eJA}	65	°C/W

Electrical Characteristics at $T_j=25^\circ\text{C}$ (unless otherwise specified)
Static Characteristics

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_D=250\mu\text{A}$	200	-	-	V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}, I_D=250\mu\text{A}$	1	2.1	3	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=200\text{V}, T_j=25^\circ\text{C}$	-	-	1	μA
		$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=200\text{V}, T_j=100^\circ\text{C}$	-	-	100	
Gate to Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	±100	nA
Drain to Source on Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10\text{V}, I_D=5\text{A}$	-	95	120	$\text{m}\Omega$
	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=4.5\text{V}, I_D=3\text{A}$	-	106	140	$\text{m}\Omega$
Transconductance	g_{fs}	$V_{\text{DS}}=5\text{V}, I_D=20\text{A}$	-	15	-	S
Gate Resistance	R_G	$V_{\text{GS}}=0\text{V}, V_{\text{DS}} \text{ Open}, f=1\text{MHz}$	-	5.5	-	Ω

Dynamic Characteristics

Input Capacitance	C_{iss}	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=100\text{V}, f=1\text{MHz}$	-	491	-	pF
Output Capacitance	C_{oss}		-	22	-	
Reverse Transfer Capacitance	C_{rss}		-	5.5	-	
Total Gate Charge	$Q_g (10\text{V})$	$V_{\text{DD}}=100\text{V}, I_D=5\text{A}, V_{\text{GS}}=10\text{V}$	-	9.8	-	nC
Total Gate Charge	$Q_g (4.5\text{V})$		-	5.8	-	
Gate to Source Charge	Q_{gs}		-	1.6	-	
Gate to Drain (Miller) Charge	Q_{gd}		-	3.2	-	
Turn on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=100\text{V}, I_D=5\text{A}, V_{\text{GS}}=10\text{V}, R_G=10\Omega,$	-	9	-	ns
Rise time	t_r		-	5	-	
Turn off Delay Time	$t_{\text{d}(\text{off})}$		-	13	-	
Fall Time	t_f		-	4	-	

Reverse Diode Characteristics

Diode Forward Voltage	V_{SD}	$V_{\text{GS}}=0\text{V}, I_F=20\text{A}$	-	0.9	1.2	V
Reverse Recovery Time	t_{rr}	$V_R=100\text{V}, I_F=5\text{A}, dI_F/dt=100\text{A}/\mu\text{s}$	-	60	-	ns
Reverse Recovery Charge	Q_{rr}		-	126	-	nC

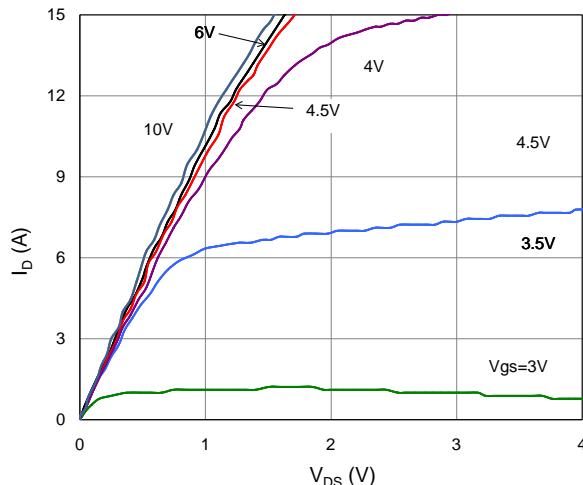
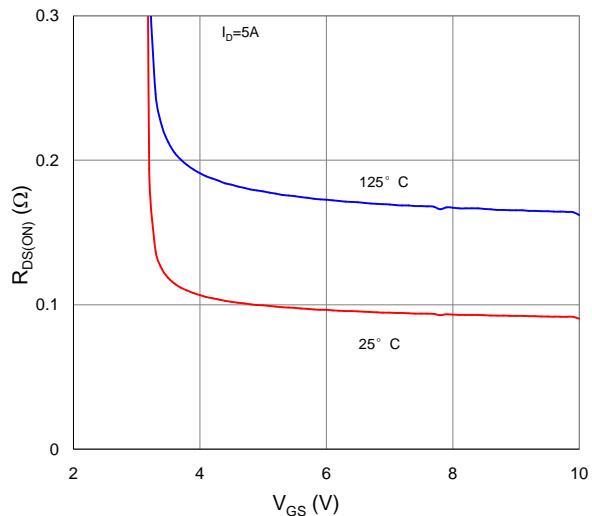
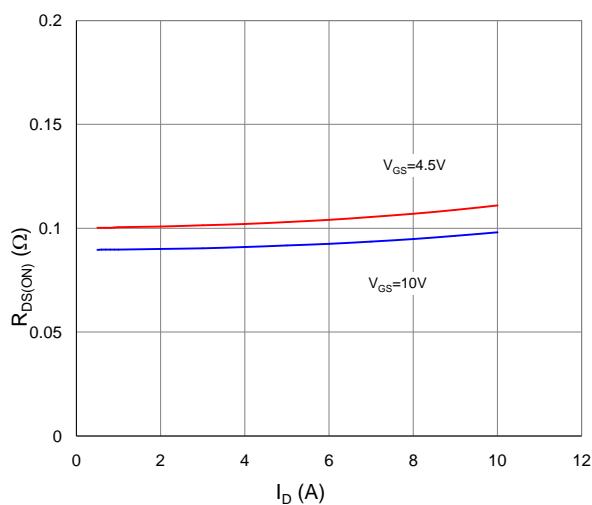
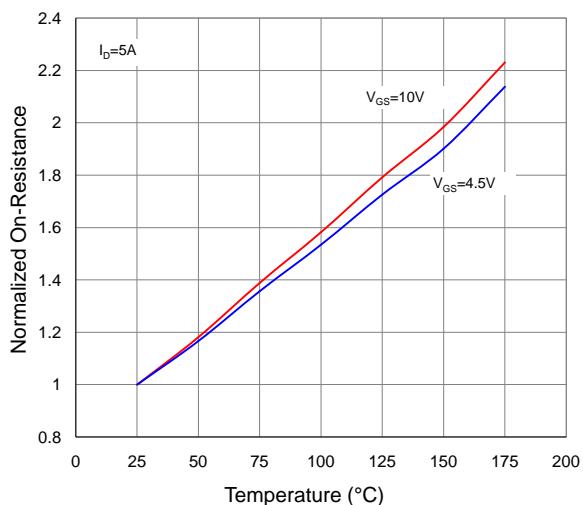
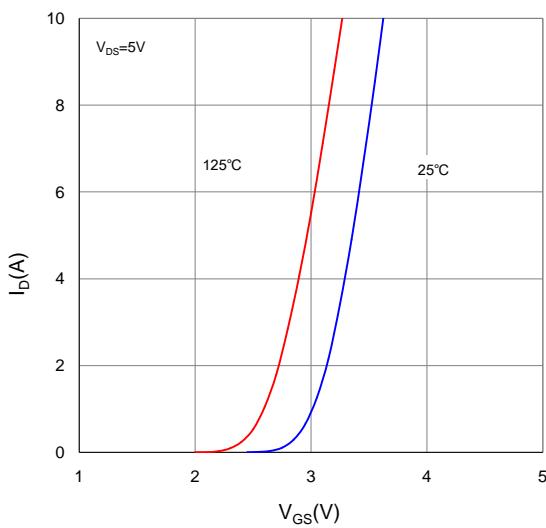
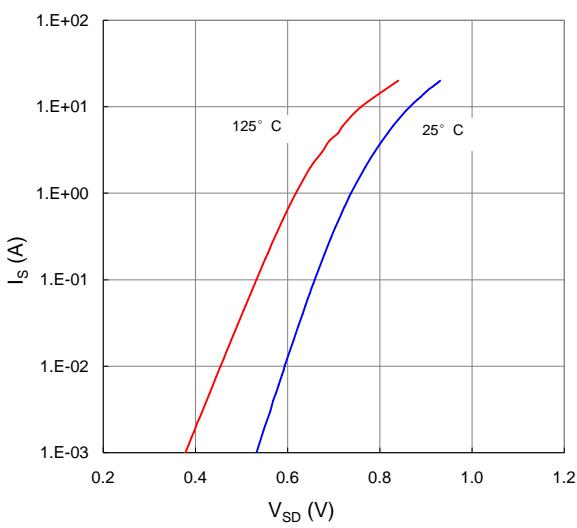
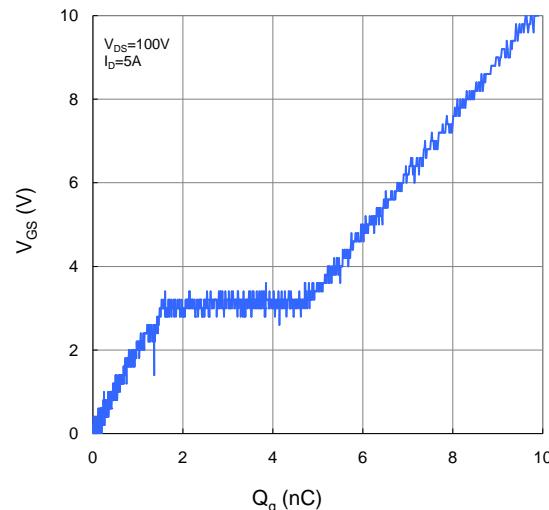
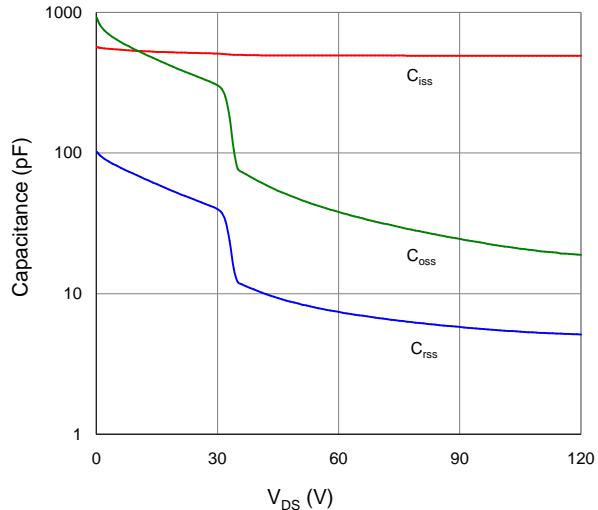
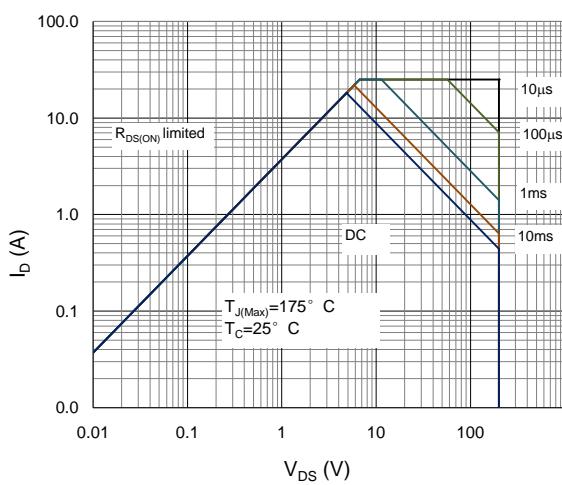
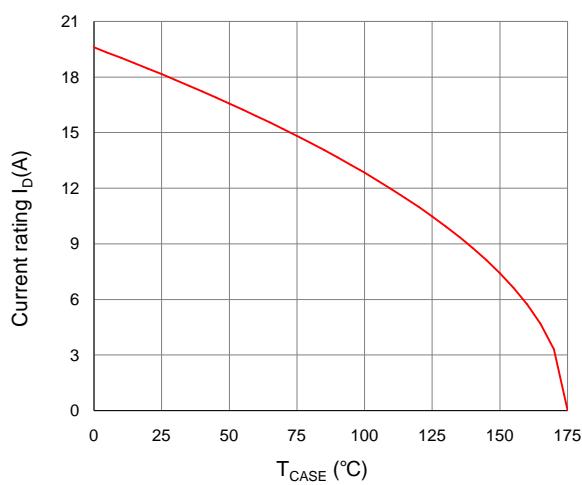
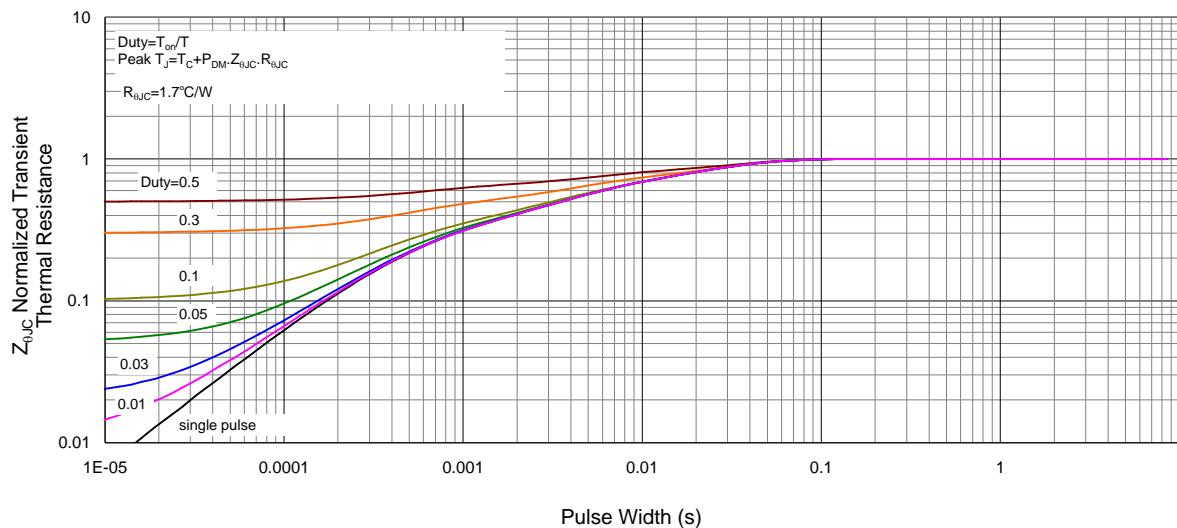
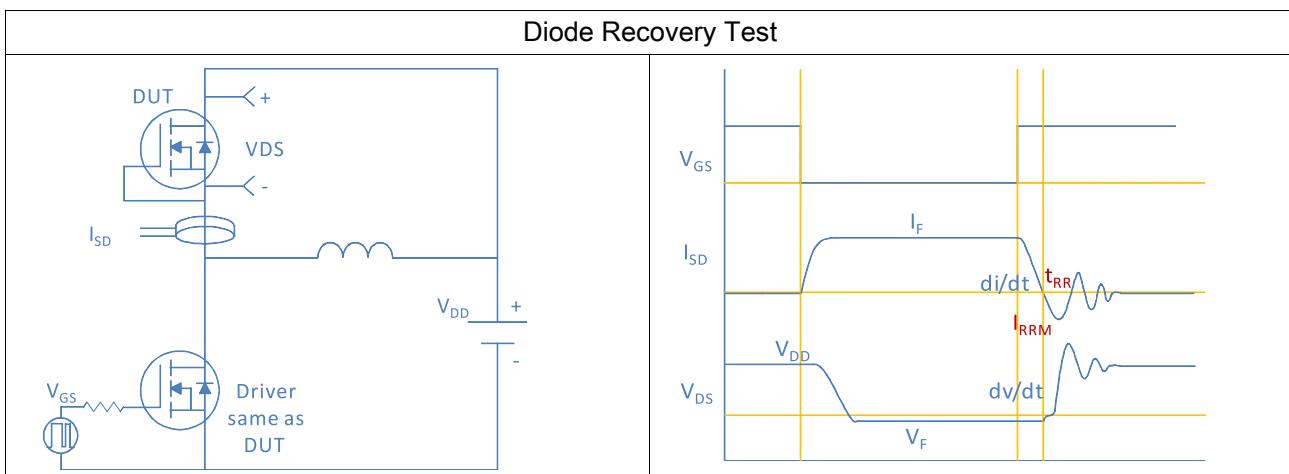
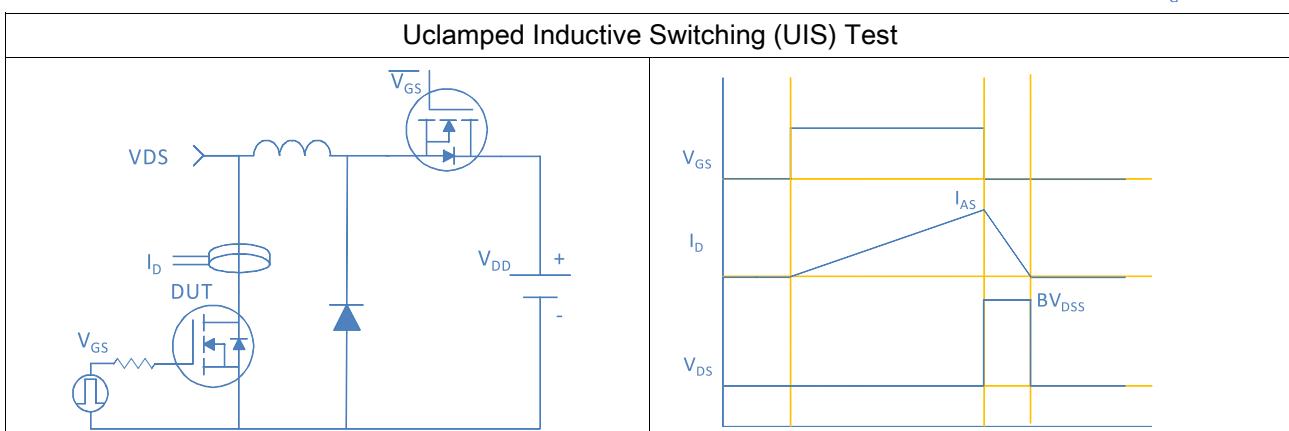
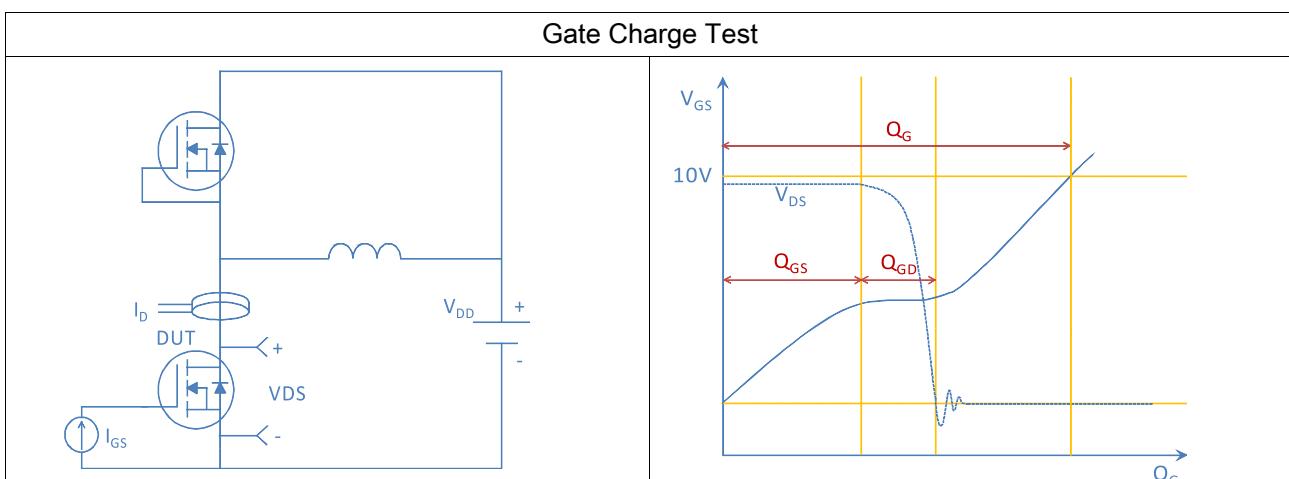
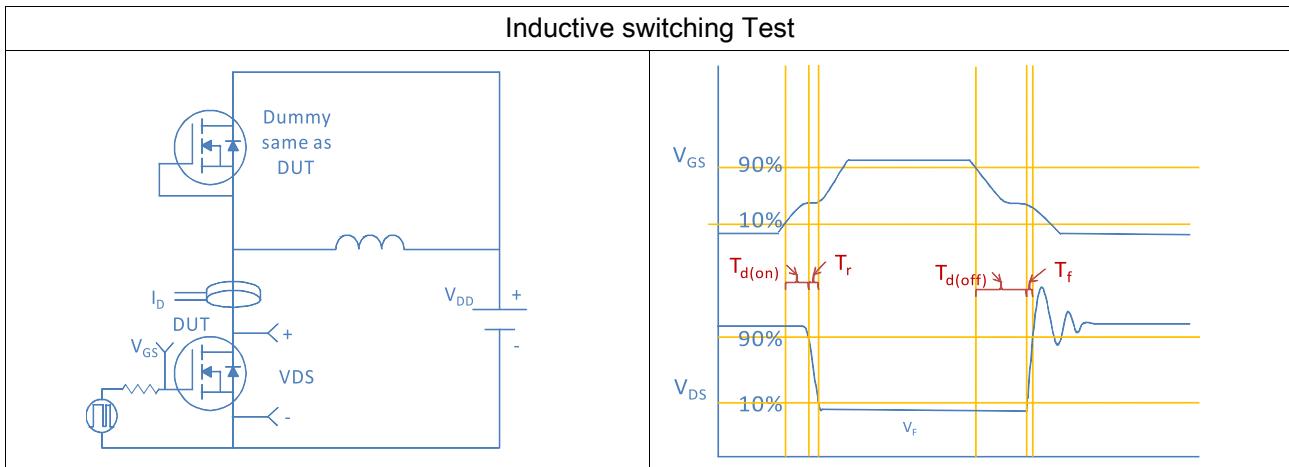
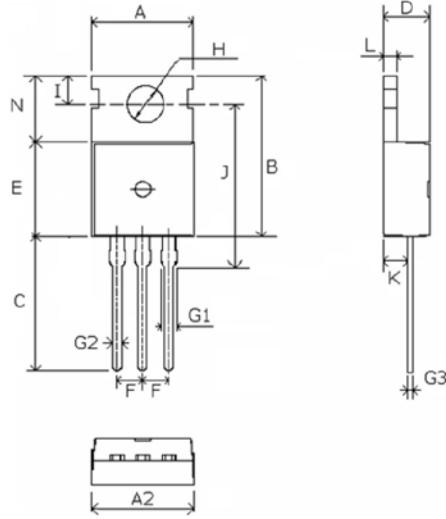
Fig 1. Typical Output Characteristics

Figure 2. On-Resistance vs. Gate-Source Voltage

Figure 3. On-Resistance vs. Drain Current and Gate Voltage

Figure 4. Normalized On-Resistance vs. Junction Temperature

Figure 5. Typical Transfer Characteristics

Figure 6. Typical Source-Drain Diode Forward Voltage


Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case




TO-220, 3 leads

Dimensions in mm unless otherwise specified



Symbol	Min	Nom	Max
A	9.66	9.97	10.28
A2	9.80	10.00	10.20
B	15.60	15.70	15.80
C	12.70	13.48	14.27
D	4.30	4.50	4.70
E	9.00	9.20	9.40
F		2.54	
G1	1.32	1.52	1.72
G2	0.70	0.82	0.95
G3	0.45	0.52	0.60
H	3.50	3.60	3.70
I	2.70	2.80	2.90
J	15.70	15.97	16.25
K	2.20	2.40	2.60
L	1.15	1.27	1.40
N	6.40	6.60	6.80